

### STGW60H65DF

## 60 A, 650 V field stop trench gate IGBT with very fast diode

Datasheet - production data

#### **Features**

- High speed switching
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance
- 6 µs short-circuit withstand time
- Very fast soft recovery antiparallel diode
- Lead free package

#### **Applications**

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- High switching frequency converters

#### **Description**

This device is an IGBT developed using an advanced proprietary trench gate and field stop structure. This IGBT is the result of a compromise between conduction and switching losses, maximizing the efficiency of high switching frequency converters. Furthermore, a slightly positive  $V_{\text{CE}(\text{sat})}$  temperature coefficient and very tight parameter distribution result in easier paralleling operation.

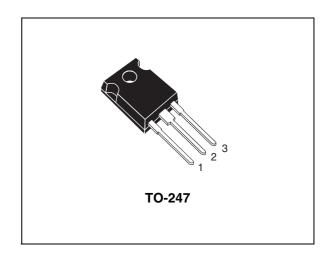


Figure 1. Internal schematic diagram

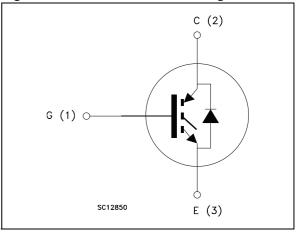


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW60H65DF	GW60H65DF	TO-247	Tube

Electrical ratings STGW60H65DF

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	650	V
Ic	Continuous collector current at T <sub>C</sub> = 25 °C	120	Α
I <sub>C</sub>	Continuous collector current at T <sub>C</sub> = 100 °C	60	Α
I <sub>CP</sub> <sup>(1)</sup>	Pulsed collector current	240	Α
V <sub>GE</sub>	Gate-emitter voltage	±20	V
I <sub>F</sub>	Continuous forward current at T <sub>C</sub> = 25 °C 120		Α
I <sub>F</sub>	Continuous forward current at T <sub>C</sub> = 100 °C	60	
I <sub>FP</sub> <sup>(1)</sup>	Pulsed forward current	240	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	360	W
t <sub>SC</sub>	Short-circuit withstand time at $V_{CC} = 400 \text{ V}$ , $V_{GE} = 15 \text{ V}$	6	μs
T <sub>STG</sub>	Storage temperature range	- 55 to 150	
T <sub>J</sub>	Operating junction temperature	- 33 10 130	°C

<sup>1.</sup> Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case IGBT	0.35	°C/W
R <sub>thJC</sub>	Thermal resistance junction-case diode	1.38	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	50	°C/W

## 2 Electrical characteristics

 $T_J = 25~^{\circ}C$  unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 2 mA	650			٧
	V <sub>CE(sat)</sub> Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 60 A		1.9		
V <sub>CE(sat)</sub>		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 60 A T <sub>J</sub> = 150 °C		2.1		V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 1 \text{ mA}$		6.0		٧
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 650 V			25	μΑ
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 20 V			250	nA

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0	-	7150 345 125	-	pF pF pF
Qg	Total gate charge	.,	-	206	-	nC
Q <sub>ge</sub>	Gate-emitter charge	$V_{CC} = 520 \text{ V, } I_{C} = 60 \text{ A,}$ $V_{GE} = 15 \text{ V}$	-	60	-	nC
Q <sub>gc</sub>	Gate-collector charge	GL	-	70	-	nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	-	67 46 1043	-	ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_{J} = 150 \text{ °C}$	-	64 49 990	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	-	41 165 34	1	ns ns ns
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_{J} = 150 \text{ °C}$	-	49 169 78	-	ns ns ns

Electrical characteristics STGW60H65DF

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon (1)	Turn-on switching losses	V <sub>CF</sub> = 400 V, I <sub>C</sub> = 60 A,		1.5		mJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_G = 10 \Omega, V_{GF} = 15 V$	-	1.1	-	mJ
E <sub>ts</sub>	Total switching losses	ng = 10 22, vgE = 13 v		2.6		mJ
Eon (1)	Turn-on switching losses	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$		2.7		mJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_G = 10 \Omega, V_{GE} = 15 V$	-	1.5	-	mJ
E <sub>ts</sub>	Total switching losses	T <sub>J</sub> = 150 °C		4.2		mJ

Eon is the turn-on losses when a typical diode is used in the test circuit in Figure 23. If the IGBT is offered
in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the
same temperature (25 °C and 125 °C).

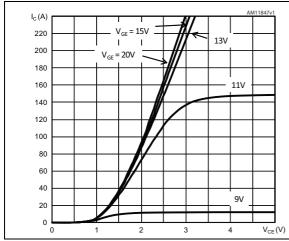
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward on-voltage	I <sub>F</sub> = 60 A I <sub>F</sub> = 60 A, T <sub>J</sub> = 150 °C	-	1.6	2.6	V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 60 \text{ A}, V_R = 400 \text{ V},$ di/dt = 1700 A/ $\mu$ s	-	62 930 30	-	ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 60 \text{ A}, V_R = 400 \text{ V},$ $di/dt = 1630 \text{ A/}\mu\text{s}$ $T_J = 150 ^{\circ}\text{C}$	-	100 2800 58	-	ns nC A

<sup>2.</sup> Turn-off losses include also the tail of the collector current.

### 2.1 Electrical characteristics (curves)

Figure 2. Output characteristics ( $T_J = -40 \,^{\circ}\text{C}$ ) Figure 3. Output characteristics ( $T_J = 25 \,^{\circ}\text{C}$ )



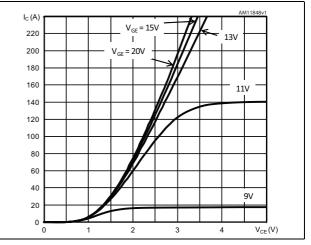
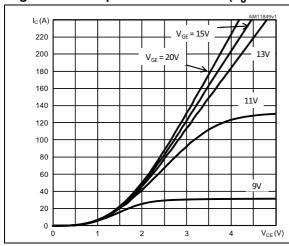


Figure 4. Output characteristics ( $T_J = 150$  °C) Figure 5. Transfer characteristics



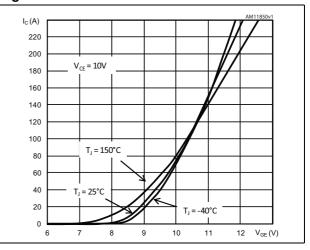


Figure 6. V<sub>CE(SAT)</sub> vs. junction temperature

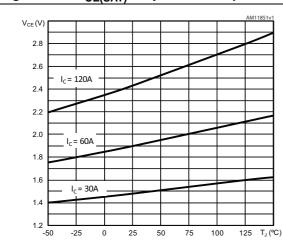
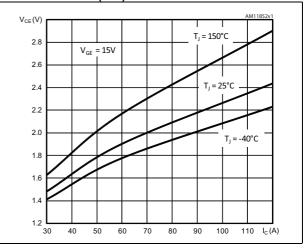


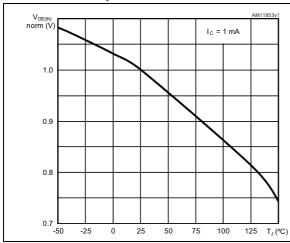
Figure 7.  $V_{CE(SAT)}$  vs. collector current



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Figure 8. Normalized  $V_{GE(th)}$  vs. junction temperature

Figure 9. Gate charge vs. gate-emitter voltage



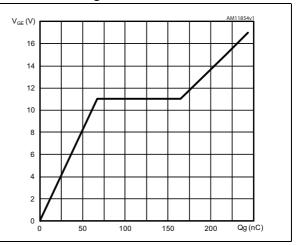
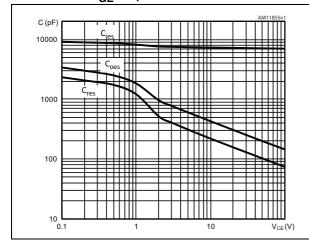


Figure 10. Capacitance variations (f = 1 MHz,  $V_{GE} = 0$ )

Figure 11. Switching losses vs. collector current



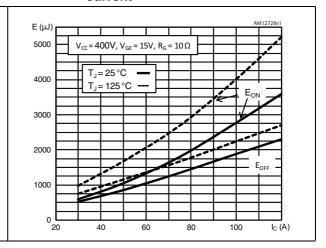
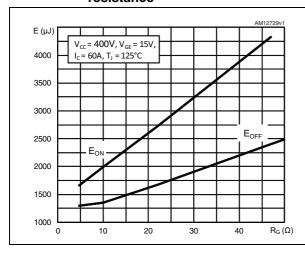
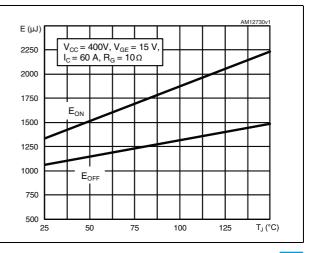


Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs. temperature





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Figure 14. Turn-OFF SOA

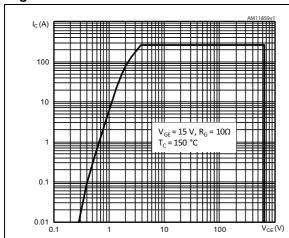


Figure 15. Short circuit time & current vs.  $V_{\text{GE}}$ 

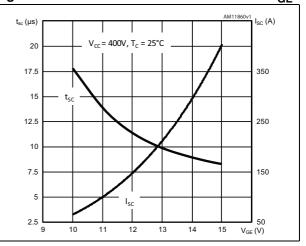
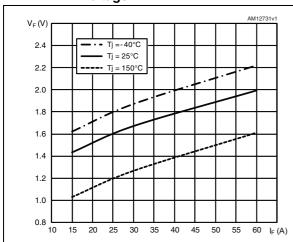


Figure 16. Diode forward current vs. forward voltage

Figure 17. Diode forward current vs. junction temperature



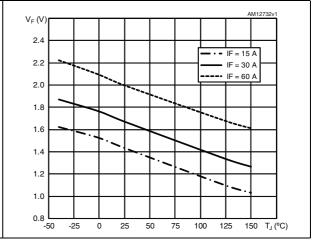
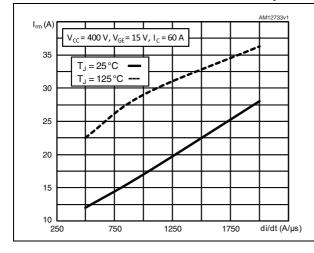
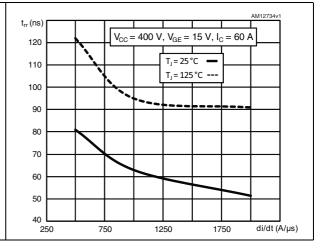


Figure 18. Reverse recovery current as a function of diode current slope

Figure 19. Reverse recovery time as a function of diode current slope

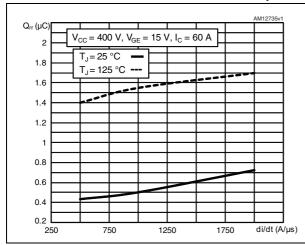




Electrical characteristics STGW60H65DF

Figure 20. Reverse recovery charge as a function of diode current slope

Figure 21. Maximum normalized  $Z_{th}$  junction to case (IGBT)



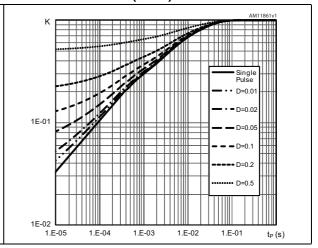
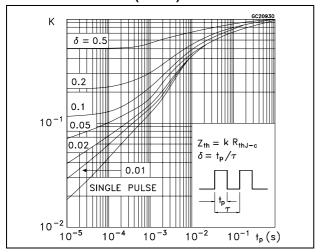


Figure 22. Maximum normalized  $Z_{th}$  junction to case (Diode)



STGW60H65DF Test circuits

## 3 Test circuits

Figure 23. Test circuit for inductive load switching

Figure 24. Gate charge test circuit

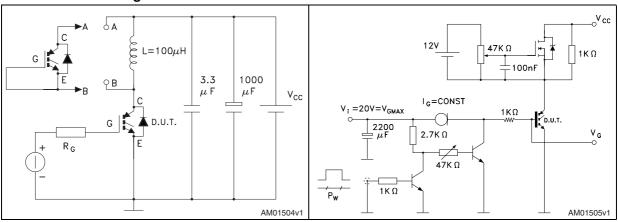
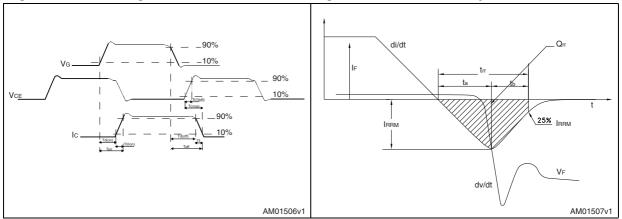


Figure 25. Switching waveform

Figure 26. Diode recovery time waveform



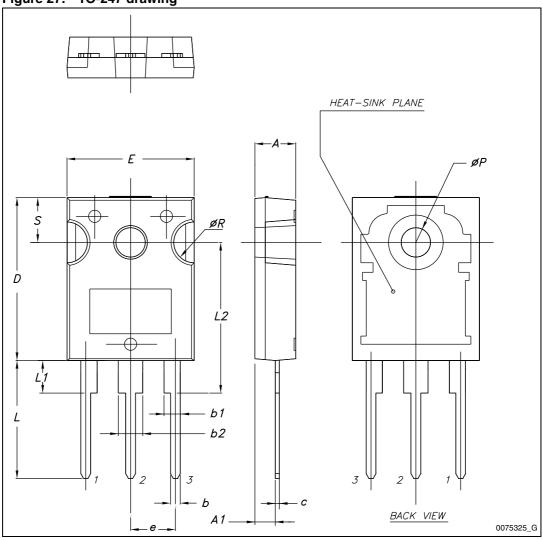
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. TO-247 mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Figure 27. TO-247 drawing



Revision history STGW60H65DF

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
28-Mar-2012	1	Initial release.
06-Jun-2012	2	Document status promoted from preliminary data production data. Added: Section 2.1: Electrical characteristics (curves) on page 5.
26-Jul-2012	3	Updated: Figure 8 on page 6.
09-Jan-2013	4	Modified: V <sub>F</sub> typ. and max. values <i>Table 8 on page 4</i> .

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